

**Surface Mount Superfast Recovery Rectifier**
**Reverse Voltage – 50 to 600 V**
**Forward Current – 1 A**
**FEATURES**

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

**MECHANICAL DATA**

- Case: SMA
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.055g / 0.002oz

**Absolute Maximum Ratings and Characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

**PINNING**

PIN	DESCRIPTION
1	Cathode
2	Anode



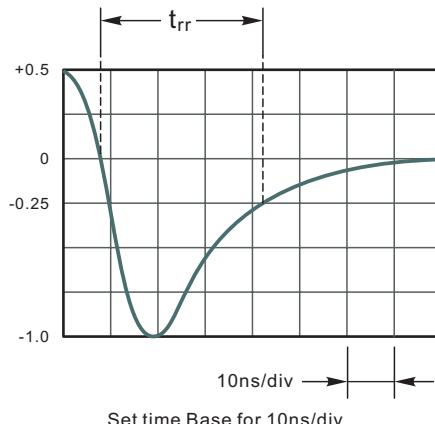
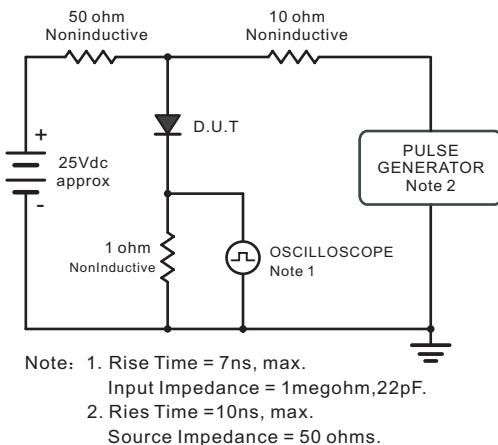
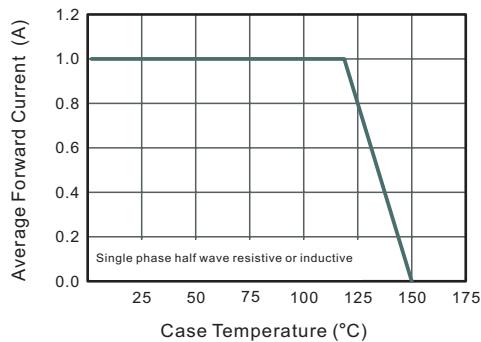
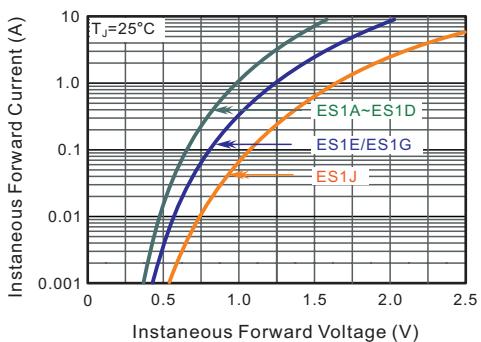
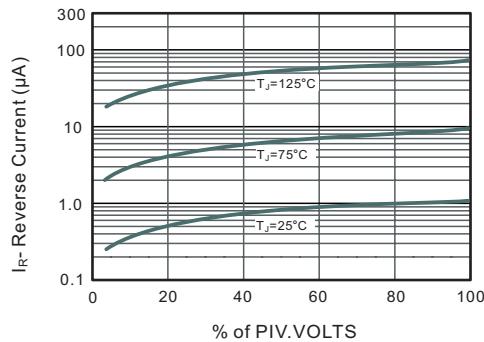
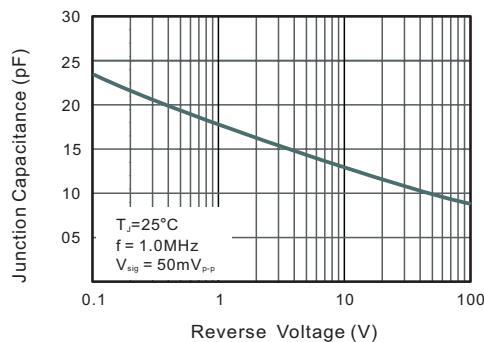
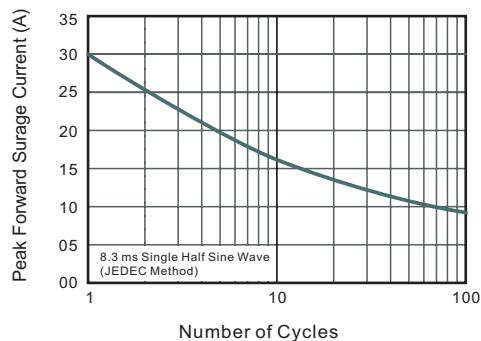
Top View

 Marking Code: ES1A~ES1J: ES1A~ES1J  
 Simplified outline SMA and symbol

Parameter	Symbols	ES1A	ES1B	ES1C	ES1D	ES1E	ES1G	ES1J	Units				
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	150	200	300	400	600	V				
Maximum RMS voltage	$V_{RMS}$	35	70	105	140	210	280	420	V				
Maximum DC Blocking Voltage	$V_{DC}$	50	100	150	200	300	400	600	V				
Maximum Average Forward Rectified Current	$I_{F(AV)}$	1						A					
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	30						A					
Maximum Forward Voltage at 1 A	$V_F$	1		1.25		1.70		V					
Maximum DC Reverse Current Ta = 25 °C at Rated DC Blocking Voltage Ta = 125 °C	$I_R$	5 100						$\mu A$					
Typical Junction Capacitance at $V_R=4V$ , f=1MHz	$C_j$	15						pF					
Maximum Reverse Recovery Time <sup>(1)</sup>	$t_{rr}$	35						ns					
Typical Thermal Resistance <sup>(2)</sup>	$R_{\theta JA}$	110						°C/W					
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150						°C					

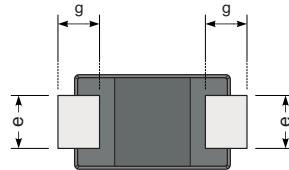
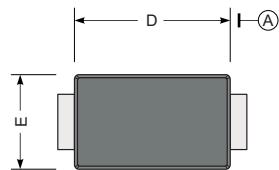
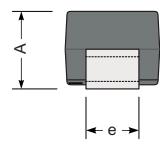
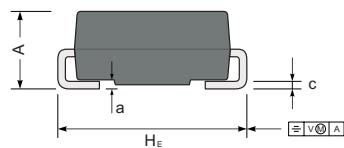
 (1) Measured with  $I_F = 0.5 A$ ,  $I_R = 1 A$ ,  $I_{rr} = 0.25 A$ .

(2) P.C.B. mounted with 1.0 X 1.0" (2.54 X 2.54 cm) copper pad areas.

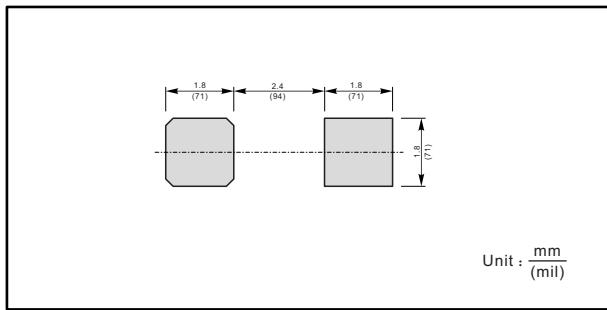
**Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram**

**Fig.2 Maximum Average Forward Current Rating**

**Fig.4 Typical Forward Characteristics**

**Fig.3 Typical Reverse Characteristics**

**Fig.5 Typical Junction Capacitance**

**Fig.6 Maximum Non-Repetitive Peak Forward Surge Current**


**PACKAGE OUTLINE**

Plastic surface mounted package; 2 leads

**SMA**


UNIT		A	D	E	H <sub>E</sub>	c	e	g	a
mm	max	2.2	4.5	2.7	5.2	0.31	1.6	1.5	0.3
	min	1.9	4.0	2.3	4.7	0.15	1.3	0.9	
mil	max	87	181	106	205	12	63	59	12
	min	75	157	91	185	6	51	35	

**The recommended mounting pad size**

**Marking**

Type number	Marking code
ES1A	ES1A
ES1B	ES1B
ES1C	ES1C
ES1D	ES1D
ES1E	ES1E
ES1G	ES1G
ES1J	ES1J